

A3
cancel ID solder balls 452, 454, once reflowed, secure plug 420 to a substrate (not shown). - -;

line 21, delete "recess" and insert therein - - bevelled edge - -;

line 24, after "bottom", insert - -, or mounting, - -;

line 26, delete "and" and insert therein - - which enter corresponding openings

A4 (not shown) in a substrate (not shown) during mounting. Further, the bottom side of the receptacle includes - -;

line 26, delete "as at" and insert therein - - to which solder masses, such as the

A5 solder balls - - and

line 26, delete the period (".") and insert therein - - shown in Figure 30, secure.

A6 As seen in Figure 33, the solder conductive pad of contact 470 is an angled portion 457 which resides in a recess 459 in the base. As customary in ball grid array assemblies, solder balls 488, 490, once reflowed, secure receptacle 456 to a substrate (not shown)

IN THE CLAIMS:

Cancel claims 3 and 21.

Amend claims 1, 4, 14, 15, 18, 26, 29 and 32.

- Sub B1
A7
1. (Once Amended) An electrical connector, comprising:
 - a dielectric base;
 - a plurality of ground or power contacts in said dielectric base and comprising:
 - a mating portion for engaging a mating [connector] component, said mating portion having an elongated cross-section; and
 - a mounting portion for securing the connector to a substrate;